DATA SHEET

NEC

GaAs MULTI-CHIP MODULE
MC-7832

870 MHz CATV 22 dB PUSH-PULL AMPLIFIER

DESCRIPTION

The MC-7832 is a GaAs Multi-chip Module designed for use in CATV applications up to 870 MHz. This unit has low distortion, low noise figure and return loss across the entire frequency band.

Reliability and performance uniformity are assured by our stringent quality and control procedures.

FEATURES

- Low distortion
- High linear gain G_L = 22.0 dB MIN. @f = 870 MHz
- Low return loss

ORDERING INFORMATION

Part Number	Order Number	Package	Supplying Form
<R> MC-7832	MC-7832-AZ	7-pin special with heatsink (Pb-Free)	25 pcs MAX./Tray

Remark To order evaluation samples, contact your nearby sales office.
Part number for sample order: MC-7832

ABSOLUTE MAXIMUM RATINGS (T_A = +25°C)

Parameter	Symbol	Ratings	Unit
Supply Voltage	V_{DD}	30	V
Input Voltage [Note]	V_i	65.0	dBmV
Operating Case Temperature	T_C	–30 to +100	°C
Storage Temperature	T_{stg}	–40 to +100	°C

Note In case of single tone

Caution Observe precautions when handling because these devices are sensitive to electrostatic discharge.

The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version.
Not all products and/or types are available in every country. Please check with an NEC Electronics sales representative for availability and additional information.

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The mark <R> shows major revised points.

The revised points can be easily searched by copying an "<R>" in the PDF file and specifying it in the "Find what:" field.

RECOMMENDED OPERATING CONDITIONS ($Z_S = Z_L = 75\ \Omega$)

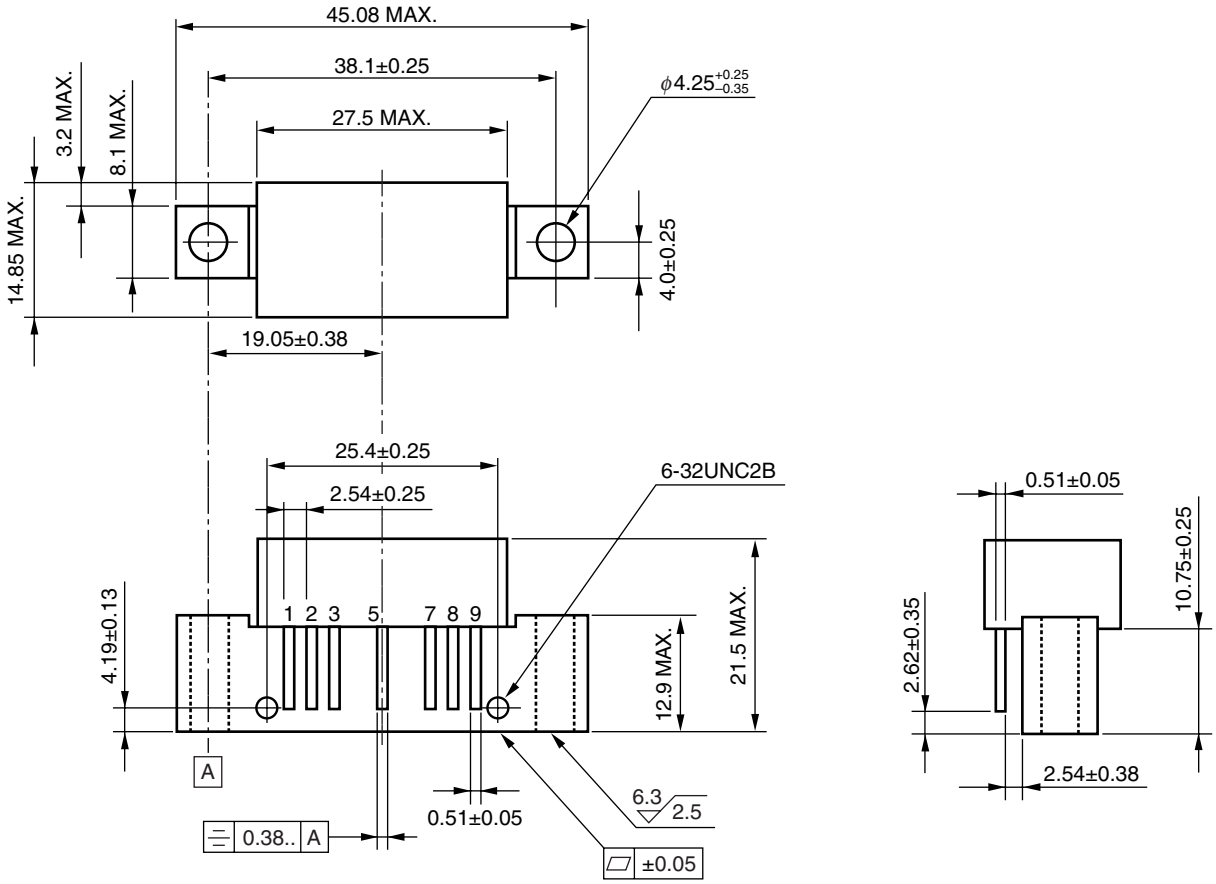
Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Supply Voltage	V_{DD}		23.5	24.0	24.5	V
Input Voltage	V_i	110 channel, Flat	–	21.0	27.5	dBmV
Operating Case Temperature	T_C		–30	+25	+85	°C

ELECTRICAL CHARACTERISTICS ($T_C = 30 \pm 5°C$, $V_{DD} = 24$ V, $Z_S = Z_L = 75\ \Omega$)

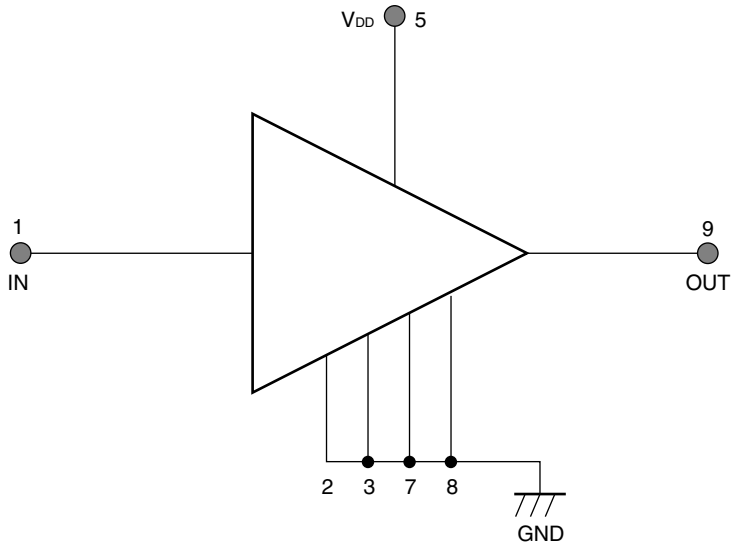
Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Linear Gain	G_L	f = 870 MHz	22.0	–	23.0	dB
Gain Slope	G_{Slope}	f = 40 to 870 MHz	0.6	–	1.4	dB
Gain Flatness	$G_{Flatness}$	f = 40 to 870 MHz, Peak to valley	–	–	0.7	dB
Noise Figure 1	NF1	f = 50 MHz	–	–	6.0	dB
Noise Figure 2	NF2	f = 870 MHz	–	–	6.5	dB
Operating Current	I_{DD}	P_{in} = None	180	–	240	mA
Composite Triple Beat	CTB	110 channel, V_O = 44 dBmV, Flat	–	–	–57	dBc
Cross Modulation	XM		–	–	–50	dBc
Composite 2nd Order Beat	CSO		–	–	–57	dBc
Input / Output Return Loss 1	RL1	f = 40 to 160 MHz	20	–	–	dB
Input / Output Return Loss 2	RL2	f = 160 to 320 MHz	19	–	–	dB
Input / Output Return Loss 3	RL3	f = 320 to 640 MHz	17.5	–	–	dB
Input / Output Return Loss 4	RL4	f = 640 to 870 MHz	16	–	–	dB

PACKAGE DIMENSIONS

7-PIN SPECIAL WITH HEATSINK (UNIT: mm)



PIN CONNECTION



NOTES ON CORRECT USE

(1) The space between PC board and root of the lead should be kept more than 1 mm to prevent undesired stress to the lead and also should be kept less than 4 mm to prevent undesired parasitic inductance.
Recommended that space is 2.0 to 3.0 mm typical.

(2) Recommended torque strength of the screw is 59 to 78 Ncm.

(3) Form the ground pattern as wide as possible to minimize ground impedance.
(to prevent undesired oscillation)
All the ground pins must be connected together with wide ground pattern to decrease impedance difference.

RECOMMENDED SOLDERING CONDITIONS

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

Soldering Method	Soldering Conditions	Recommended Condition Symbol
Partial Heating	Peak temperature (pin temperature) : 350°C or below[Note] Soldering time (per pin of device) : 3 seconds or less	–

Note The point of pin part heating must be kept more than 1.2 mm distance from the root of lead.

- **The information in this document is current as of December, 2006. The information is subject to change without notice. For actual design-in, refer to the latest publications of NEC Electronics data sheets or data books, etc., for the most up-to-date specifications of NEC Electronics products. Not all products and/or types are available in every country. Please check with an NEC Electronics sales representative for availability and additional information.**
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M8E 02. 11-1

Caution GaAs Products	This product uses gallium arsenide (GaAs). GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points. • Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below. 1. Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials. 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal. • Do not burn, destroy, cut, crush, or chemically dissolve the product. • Do not lick the product or in any way allow it to enter the mouth.